Effect of alumina doping on structural, electrical, and optical properties of sputtered ZnO thin films

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Abstract

A systematic study of the influence of alumina (Al₂O₃) doping on the optical, electrical, and structural characteristics of sputtered ZnO thin films is reported in this study. The ZnO thin films were prepared on 1737F Corning glass substrates by R.F. magnetron sputtering from a ZnO target mixed with Al₂O₃ of 0–4 wt.%. X-ray diffraction (XRD) analysis demonstrates that the ZnO thin films with Al₂O₃ of 0–4 wt.% have a highly (002) preferred orientation with only one intense diffraction peak with a full width at half maximum (FWHM) less than 0.5°. The electrical properties of the Al₂O₃-doped ZnO thin films appear to be strongly dependent on the Al₂O₃ concentration. The resistivity of the films decreases from 74 Ω·cm to 2.2×10⁻³ Ω·cm as the Al₂O₃ content increases from 0 to 4 wt.% The optical transmittance of the Al₂O₃-doped ZnO thin films is studied as a function of wavelength in the range 200–800 nm. It exhibits high transparency in the visible-NIR wavelength region with some interference fringes and sharp ultraviolet absorption edges. The optical bandgap of the Al₂O₃-doped ZnO thin films show a short-wavelength shift with increasing of Al₂O₃ content.

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1. Introduction

Transparent and conductive zinc oxide (ZnO) based thin films have been recently investigated for electronic and optoelectronic device applications such as transparent electrodes, solar cells, heat reflecting windows, and sensors [1–3]. These films exhibit high n-type conductivity with optical transparency in the visible-NIR spectral range and reflection of infrared thermal radiation. The ability to withstand exposure to an aggressive plasma makes ZnO very suitable for the use as a front window in an amorphous silicon solar cell. In photovoltaic and other possible optoelectronic applications, the development of thin coatings with a high transmittance and a low sheet resistance is an important topic. It has been reported that the ZnO with high conductivity is due to oxygen deficiency and/or interstitial Zn ions [4,5]. Moreover, the high transmission of ZnO is associated with its wide bandgap of around 3.3 eV. In contrast to other oxide semiconductor materials, ZnO is nontoxic and easy to fabricate by various thin-film deposition techniques. Additionally, the abundance of ZnO in the earth makes it available at a low cost. The influence of fabrication parameters on the structural, electrical and optical properties of ZnO-based thin films was investigated in various studies [6–9]; however, more detailed investigation of the effect of Al₂O₃ dopant on the characteristics of ZnO thin films is rarely found in the published literatures. In this study, a systematic study of the influence of Al₂O₃ dopant on the optical, electrical, and structural characteristics of R.F. magnetron sputtered ZnO thin films is reported. The correlation between film properties and Al₂O₃ concentration is also established.

2. Experimental

ZnO thin films were grown on 1737F Corning glass substrate at room temperature by a R. F. magnetron sputtering system. The Al₂O₃-doped ZnO targets were prepared from a mixture of ZnO (purity, 99.99%) and Al₂O₃(purity, 99.99%) by a standard solid-state reaction process. Before deposition, the Corning glass substrate was ultrasonically cleaned in acetone, ethanol, and distilled water sequentially. Immediately after cleaning, the glass substrate was loaded into the sputtering chamber followed

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by evacuation. The base pressure of the sputtering chamber was $1 \times 10^{-3}$ Pa, and the working pressure was kept constant at 0.34 Pa with an argon gas flow rate of 10 sccm. All films were prepared at a fixed power of 80 W. The deposition rate was in the range of 2.0–3.5 nm/min.

The crystal structure and orientation of the ZnO thin films were characterized by X-ray diffraction (XRD). The surface morphology of the films was observed by scanning electron microscopy (SEM). The film thickness was determined from SEM images of the fracture cross-section area of the ZnO films. The electrical resistivity was measured by four-point probe technique. The optical transmission spectra through the ZnO thin films were recorded using an ultraviolet-visible spectrophotometer in the wavelength range of 200–800 nm at room temperature.

3. Results and discussion

Fig. 1 shows the surface images of ZnO films with various Al$_2$O$_3$ doping concentrations. It is found that the Al$_2$O$_3$ doping concentration has a significant influence on ZnO film surface structure. The grain size decreases as the Al$_2$O$_3$ concentration increases. The average grain sizes of the films with Al$_2$O$_3$ of 0 wt.%, 1 wt.%, 2 wt.% and 4 wt.% are 160, 64, 47, and 41 nm, respectively. It is indicated that Al$_2$O$_3$ is a grain growth inhibitor in ZnO films.

Fig. 2 illustrates the XRD patterns of the ZnO films with various Al$_2$O$_3$ doping concentrations. All of the films exhibit the preferred (002) orientation due to the minimal surface energy in the ZnO hexagonal wurtzite structure [10]. The XRD patterns also show no diffraction from randomly oriented grains or impurity phases. The intensity of the (002) peaks decreases with increasing Al$_2$O$_3$-doping. In addition, the location of the (002) peaks was shifted to lower 2θ angles, from 34.86° to 34.36° as Al$_2$O$_3$-doped content increases from 0 to 4 wt.%. The lattice parameter is expected to be smaller in Al$_2$O$_3$-doped ZnO.

The effect of Al$_2$O$_3$ concentration on the growth rate of ZnO thin films is illustrated in Fig. 3. The average growth rate was calculated based on the mean value of thickness from the cross-section images of thin films. It is shown that the growth rate steadily decreases with the increase of amount of Al$_2$O$_3$ dopant, which becomes constant at about 2.0 nm/min when the Al$_2$O$_3$ content is larger than 2 wt.%. For 4 wt.% Al$_2$O$_3$-doped film, the growth rate is observed to be lower, an approximately 0.6 times that of undoped ZnO films. The growth rate decrease with increasing Al$_2$O$_3$ dopant suggests that ZnO growth is limited by Al$_2$O$_3$ addition.

The dependence of the resistivity of ZnO thin films on the Al$_2$O$_3$ doping concentration is shown in Fig. 4. The resistivity decreases with an increase of Al$_2$O$_3$ dopant in the range of 0–4 wt.%. The electrical resistivities for pure and 4 wt.% Al$_2$O$_3$-doped ZnO films are 74 $\Omega$·cm and 2.2×$10^{-3}$ $\Omega$·cm,
respectively. The difference of the resistivity between undoped and Al$_2$O$_3$ doped (4 wt.%) films is about five orders of magnitude. It is found that the resistivity decreases markedly at lower Al$_2$O$_3$ doping concentrations and is nearly constant above 2 wt.% with a value around $2.2 \times 10^{-3} \ \Omega \cdot \text{cm}$. There is no apparent change in the electrical resistivity for the ZnO films with above 2 wt.% Al$_2$O$_3$. The drop in resistivity is attributed to the creation of defects in ZnO films due to the Al$_2$O$_3$ dopant. We may presume that the aluminum will replace zinc in the ZnO, which can be written as

$$\text{Al}_2\text{O}_3 = 2\text{Al}^{3+} + 3\text{O}^2_- + \text{V}^{2+}$$ \hspace{1cm} (1)$$

Therefore, a vacancy is formed at a Zn$^{2+}$ site in the lattice of Al$_2$O$_3$ doped ZnO. The following defect equation may also occur

$$\text{O}^2_- = \frac{1}{2}\text{O}_2(g) + \text{V}^{2+} + 2e^-$$ \hspace{1cm} (2)$$

By adding Eqs. (1) and (2), we can get

$$\text{Al}_2\text{O}_3 = 2\text{Al}^{3+} + 2\text{O}^2_- + \frac{1}{2}\text{O}_2(g) + 2e^-$$

The change in the resistivity shown in Fig. 4 may be attributed to such an increase in electron concentration.

The Al$_2$O$_3$ doping causes ZnO films with smaller grain size and higher charge carrier density in this study. The ZnO films with higher Al$_2$O$_3$ doping concentration will have a higher charge carrier density. In addition, the smaller grain size caused by higher Al$_2$O$_3$ concentration may result in higher grain boundary scattering. It is well known that higher charge carrier density will result in lower resistivity; however, higher grain boundary scattering will cause higher resistivity. According to the resistivity measurement results, we can reasonably infer that the decrease of resistivity of the ZnO films is mainly due to the increase of charge carrier density.

Fig. 5 shows the optical transmittance spectra of ZnO thin films with various Al$_2$O$_3$-doped concentrations. As shown in Fig. 5, the ZnO films have a high average transmittance of approximately 85% in the wavelength range 200–800 nm with oscillatory character due to interference effects [11]. The average transmittance of the ZnO films is increased by Al$_2$O$_3$ doping. The higher the Al$_2$O$_3$ dopant concentration, the more transparent the films become. Based on the SEM and XRD experimental results, the thickness of the ZnO films decreases as the content of Al$_2$O$_3$ dopant is increased. The thickness of the ZnO films with Al$_2$O$_3$ of 0 wt.%, 0.5 wt.%, 1.0 wt.%, 2.0 wt.%, and 4.0 wt.% is 211, 183, 176, 140, and 130 nm, respectively.

It is found that ZnO films have sharp ultraviolet absorption characteristics in the transmittance spectra. The absorption edge is observed in the wavelength range of 300–400 nm for the films investigated. The absorption edge shifts toward higher energy sides for the ZnO films formed at higher Al$_2$O$_3$ doping levels. According to the position of the absorption edge, the energy gap of the ZnO films is evaluated as about 3.4 eV. The evaluation of the energy gap from absorption edge position assumes that the ZnO films have a direct transition. What is more notable is that the various thicker layers with interference follow the “envelope” of the doped films, indicating that none of the films show absorption down to about 370 nm and a “shoulder” on the curve develops, showing increase in optical bandgap most likely due to the Burstein-Moss effect [12].
4. Conclusions

Highly transparent conductive ZnO thin films with various Al₂O₃ doping concentrations were produced on 1737F Corning glass substrates by R.F. magnetron sputtering. These ZnO films have a highly (002) preferred crystal orientation. The grain size of ZnO thin films decreases as the Al₂O₃ content is increased in the doping range of 0–4 wt. %. The electrical resistivity significantly decreases from 74 Ω·cm for pure ZnO to 2.2×10⁻³ Ω·cm for 4 wt.% Al₂O₃-doped ZnO films. The charged carrier density has larger effect on the resistivity of Al₂O₃-doped ZnO films in comparison to grain size. Optical transmittance measurement shows that an average transmittance above 85% in the visible range is obtained for ZnO films deposited at different Al₂O₃ doped concentrations. The average transmittance increases when the Al₂O₃ dopant increases. The ultraviolet absorption edge is also observed in the wavelength range of 300–400 nm for all the ZnO films. These sharp absorption edges correspond to the energy gap of around 3.4 eV with the assumption of the direct transition.

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